

15th November, 2007

TO : Sri Siddhartha Institute of Technology
Tumkur

Dear Prof.K.B.ShivaKumar

Subject: MOU and Welcome to Campus Connect Program

We thank you for taking steps to identify the Single Point of Contact (SPOC) and forming the Campus Connect core team at your institution. We welcome all new members to the Campus Connect community and we are confident that your team will make the initiative a great success in your institution.

We are pleased to inform you the following:

1. A copy of signed MOU is attached.
2. Your institution is associated with Infosys Development Center (DC) at **Bangalore**.
3. A senior Infosys DC SPOC is identified to collaborate with your institution to take the initiative forward. The DC SPOC is **Anoop Singh**, Email-ID: **Anoop_Singh@infosys.com**
4. A Campus Connect Welcome kit that would help you to brief your team. Welcome Kit also serves as a reference for planning and reviews with Infosys. Welcome kit comprises of following documents.
 - 9 Program Announcements – 3 sets
 - Foundation Program Deployment Guide – 1 Copy
 - Soft Skill Deployment Guide – 1 Copy
 - Campus Connect Courseware CD.

We are sending 3 copies of Program Announcements which is meant for College Principal, SPOC, and Core Team.

We request you to initiate steps to complete internal action planning and share the same with the above Infosys DC SPOC for review. Please complete the review before December 15th, 2007. Once mutually reviewed, the plan becomes the reference document for Campus Connect implementation in your institution.

All your future communication need to be addressed to the Infosys DC SPOC.

Looking forward to mutually beneficial relationship.

With Warm Regards



Srikantan (Tan) Moorthy,
Vice President and Head,
Education and Research Dept.,
Infosys Technologies Ltd.

INFOSYS TECHNOLOGIES LIMITED

Regd. Office: Electronics City, Hosur Road

Bangalore 560 100, India.

Tel : 91 80 2852 0261 Fax : 91 80 2852 0362

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Memorandum of Understanding (MOU)

This MOU is between Infosys Technologies Ltd. (hereafter referred to as Infosys), and SRI SIDDHARTHA INSTITUTE OF TECHNOLOGY (hereafter referred to as University / College) for the purpose of enriching the technical education process and to jointly work for enhancing the quality of education imparted to students of all the engineering disciplines in the field of Information Technology (IT).

Infosys is a company incorporated under the laws of India with its registered office at Electronics City, Hosur Road, Bangalore – 560 100, India. (hereinafter referred to as “Infosys”) SRI SIDDHARTHA INSTITUTE OF TECHNOLOGY University _____ College is an university / engineering college committed to educational excellence having its registered office at TUMKUR _____

(hereinafter referred to as “University”)

Terms & Conditions:

1. Nature of Relationship

1.1. This MOU is for collaboration between both parties, for mutual benefit, for the many purposes set out in Annexure I to enhance the quality of the educational experience for students of the University / College.

1.2. This MOU shall be valid for 3 years from the date and each party shall be at full liberty to terminate the collaboration, with a notice period of 3 months.

1.3. Both parties shall take all reasonable steps to ensure the successful completion of the collaboration, and co-operate with each other in duly carrying out the obligation agreed upon.

2007



82

- 2 -

1.4 Infosys shall provide the University / College with the agreed upon incentives and materials, and the University shall use these as per Infosys' guidelines. The University will have to bear all expenses such as providing infrastructure, network and Internet access and other facilities required for the education and training.

Infosys will also provide the partner with adequate publicity material such as handouts, information brochures and posters. The University shall return any returnable materials to Infosys on the termination or expiry of this MoU, or when requested to do so by Infosys.

2. Mutual Obligation

2.1. This collaboration shall not be exclusive to both parties and shall not disallow each party from having similar collaboration with others. Except as expressly stated in this MoU, there shall be no obligation on any party to compensate the other in any manner or to make any claim.

2.2. Each party shall meet the expenses between them as mutually agreed.

2.3. Each party shall respect the other's intellectual property (IP) and shall not use any trade name, trade mark, symbol or designation belonging to the other, without prior written approval. No party shall hold out as an agent or representative of the other or create any liability for the other. The parties shall indemnify the other for breach of this clause.

2.4. Both parties shall maintain confidentiality about any information, course material, plans, discussions, strategies or any material which shall be deemed to be confidential and marked accordingly. Any information, course material or the like in the public domain shall not be part of this commitment.

3. Limitation and Warranties

3.1. Each party shall ensure that the other is not put to any liability for any act of the respective party.

3.2. Each party represents that they have the full power and authority to enter into this MOU in general.

3.3. Each party shall ensure that they do not actively solicit the faculty of the respective parties who were involved with the Campus Connect Program during the period of such faculty's involvement with the Program and for six (6) months thereafter. This restriction shall not apply to employees of one party who have independently applied to the other party without solicitation by that other party.

2007



Information Sheet

Name and Address of the College (in Capital Letters): _____
 SRI SIDDHARTHA INSTITUTE OF TECHNOLOGY
 Maralur, Tumkur , Karnataka, India

Pin 572 105
 Phone: 91 95816 - 2201724 Fax: 91 95816 - 2201724

MOU Signed By:

Name	Role\Designation	E-mail ID	Landline Phone	Cell
Dr. K.A.Krishnamurthy	Principal	ssitprincipal@gmail.com	95816 - 2200314	9448145319

Single Point Of Contact (SPOC):

Name	Dept\Role\Designation	E-mail ID	Landline Phone	Cell
Prof.K.B.ShivaKumar	Head, Dept. of Training & Placement	kbsssit@yahoo.com	95816 - 2201724	9448661097

Campus Connect Core Team:

Name	Dept\Role\Designation	E-mail ID	Landline Phone	Cell
Prof.M.Siddappa	HOD, Dept. of CSE	msiddu_ssit@rediffmail.co m	0816 - 2200314 E: 221	9448077405
Prof.K.Karunakara	HOD, Dept. of ISE	karunakarak@gmail.com	0816 - 2200314 E: 235	9449623303
Prof.M.Z.Kurian	HOD, Dept. of ECE	mzkurianvc@yahoo.com	0816 - 2200314	0844022363
Prof.H.S.Jayaram	HOD, Dept. of TCE	jramssit@yahoo.co.in	0816 - 2200254	9845297039

The Campus Connect Program has been briefed and discussed with all the above faculty members.
 Yours Sincerely

Prof.K.B.Shiva Kumar
 (Name)

Note:

1. All Fields are mandatory
2. Form should be signed by Principal or Authorized person nominated by Principal.

4. General

4.1. Both parties will designate a representative from its side who will be the primary point of contact on behalf of that party.

4.2. Both parties shall not use the name of the other in any advertisement or make any public announcement without the prior written approval of the other.

4.3. Both the parties agree that Infosys is not obliged on account of this MOU to recruit any fixed number of students from the university / college.

4.4 Any dispute under this MoU will be settled in Bangalore through arbitration, if necessary.

In written whereof both parties put their hard seal on the day, month and year herein mentioned.

Date: 06-NOV-2007

Date: 2

Place: Bangalore

Place:

Name: Saikant (Tan) Modetty

Name: Dr. K.A. KRISHNAMURTHY

Designation: VP & Head - E&R

Designation: PRINCIPAL

Institute: SRI SIDDHARTHA INSTITUTE OF TECHNOLOGY.

Signature:

Signature:



Dr. K.A. Krishnamurthy

23/10/07

Authorized Signatory
For Infosys

Authorized Signatory
For University / College

Seal **Vice President & Head
Education & Research Department
Infosys Technologies Ltd.
Plot No. 44 & 97A
Electronic City, Hosur Road,
Bangalore - 560 100**

Seal: